



LIST OF PUBLICATIONS CITED BY APPLICANT	<u>Attorney Docket No.</u> SEL 231	<u>Serial No.</u> 09/724,002
	<u>Applicant</u> Shunpei YAMAZAKI et al	
	<u>Filing Date</u> November 28, 2000	<u>Group</u> 1734

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
K ↓	4,602,192	07/22/86	Nomura et al	315	169.3	11/27/84
	5,670,792	09/23/97	Utsugi et al	257	59	10/12/94
	6,023,308	02/08/00	Takemura	349	42	11/26/97

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE

OTHER PUBLICATIONS

(Including Author, Title, Date, Pertinent Pages)

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EXAMINER: KARLA MOORE	DATE CONSIDERED: 11/15/02
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\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.



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U.S. PATENT DOCUMENTS						
<u>*EXAMINER INITIAL</u>	<u>DOCUMENT NUMBER</u>	<u>DATE</u>	<u>NAME</u>	<u>CLASS</u>	<u>SUB- CLASS</u>	<u>FILING DATE</u>
ku	6,432,561	08/13/02	Yamazaki	428	690	07/13/00
FOREIGN PATENT DOCUMENTS						
	<u>DOCUMENT NUMBER</u>	<u>DATE</u>	<u>NAME</u>	<u>CLASS</u>	<u>SUB- CLASS</u>	<u>FILING DATE</u>
OTHER PUBLICATIONS (Including Author, Title, Date, Pertinent Pages)						
ku	U.S. Patent Application No. 09/619,486 (pending) to Yamazaki filed July 19, 2000, including specification, abstract, claims, drawings, PTO filing receipt and amended claims.					
<u>EXAMINER:</u> KARLA MOORE				<u>DATE CONSIDERED:</u> 11/8/02		
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